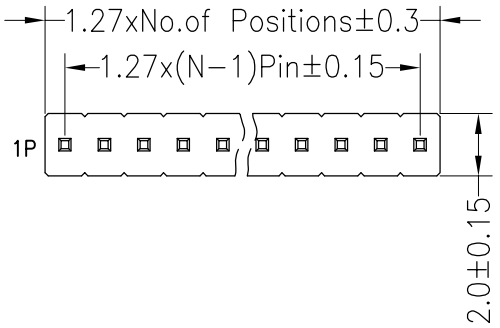
HSF RoHS

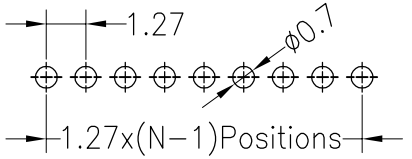
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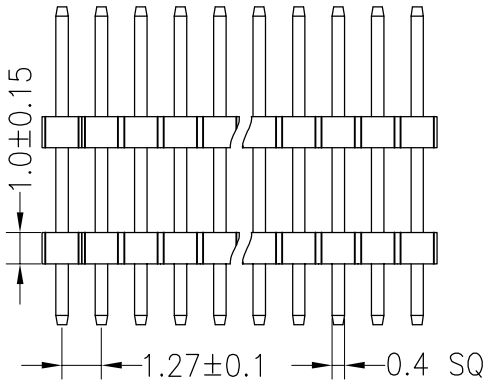
SPECIFICATIONS
Rated Current:1.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:500V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c to +105°c

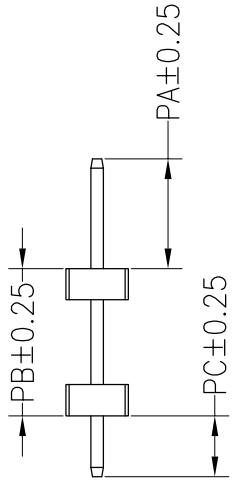
Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: PA6T
Max.Processing Temp: 230°C for 30−60 seconds
(260°C for 10 seconds)



Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)







Ordering Information

1410 21 XX X N XX S XXX X 01

- No.of Pins Per Row 1*50
- Insulator Material Option
  A=BK−PBT
  C=BK−PA6T
  D=BK−PA46
  E=BK−PA9T
  F=BK−LCP
- Contact Plating
  G1:1U" Gold
  G2:1.5U" Gold
  G3:2U" Gold
  G4:3U" Gold
  G5:5U" Gold
  S0:Gold Flash/Tin
  SN:Tin
- Pin Length
- Packing
  0=PE Bag
  A=Tray
  T=Tube
  P=Tube+Cap
  R=Reel+Cap
  M=Reel+Mylar

Dimension antitheses list				
ITEM	PA	PB	PC	L
Standard	2.80	8.00	2.80	13.60

REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2012.03.28	NEW DRAWING	

OPERATION		DRAW	Liu Miao	12.03.28	SCALE	FIT
X.X	±0.30				UNIT	mm
X.XX	±0.20	CHECK			SIZE	A4
X.XXX	±0.10				SHEET	1/1
Angle	±3°	APPROVE			PROJ.	
DIM	TOL					

WFD CONN 深圳市旺富达电子有限公司 SHEN ZHEN WFD ELECTRONICS CO., LTD

PART NO.	141021XXXNXXSXXXX01
TITLE:	1.27PH 2+H1.0mm 1xNpin DIP